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# S32 Design Studio for Power Architecture 2017.R1

# 1. Release description

Freescale, a subsidiary of NXP Semiconductors, is pleased to announce the release of the S32 Design Studio for Power Architecture 2017.R1 for Automotive and Ultra-Reliable MCUs. The S32 Design Studio is based on the Eclipse open development platform and integrates the Eclipse IDE, GNU Compiler Collection (GCC), GNU Debugger (GDB), and other open-source software to offer designers a straightforward development tool with no code-size limitations.

#### 1.1. Release content

- Eclipse Neon 4.6 Framework
- GNU Build Tools for e200 processors (support VLE and BookE ISA, based on gcc 4.9.4, binutils 2.28 and gdb 7.8.2)
- Libraries included: newlib, newlib-nano and Freescale EWL2
- P&E Multilink/Cyclone/OpenSDA (with P&E GDB Server)
- New Project wizard to create application and library projects for supported devices
- Peripherals Register and Special Purpose Registers View
- Graphical tool for creating SPT algorithms
- Fully integrated MPC5748G/MPC5746C SDK EAR v.0.8.1. For the details on the feature set

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of SDK please refer to SDK Release notes and Reference Manuals<sup>1</sup>

- SDK management included:
  - FreeMaster Serial Communication driver
  - Automotive Math and Motor Control Libraries
- Diab compiler support by new project wizard<sup>2</sup>
- Lauterbach, iSystem, and PLS debuggers support by new project wizard
- Kernel Aware debugging for FreeRTOS, eCOS, OSEK.
- Devices supported:
  - o S32R274
  - o S32R372
  - MPC5775K, MPC5774K
  - MPC5746R, MPC5745R, MPC5743R
  - MPC5777M
  - MPC5777C
  - MPC5748G, MPC5747G, MPC5746G
  - MPC5745B, MPC5744B, MPC5746B, MPC5744C, MPC5745C, MPC5746C
  - MPC5744P, MPC5743P, MPC5742P, MPC5741P
  - MPC5601P, MPC5602P, MPC5603P, MPC5604P
  - MPC5644B, MPC5644C, MPC5645B, MPC5645C, MPC5646B, MPC5646C
  - MPC5601D, MPC5602B, MPC5602C, MPC5602D, MPC5603B, MPC5603C, MPC5604B, MPC5604C, MPC5605B, MPC5606B, MPC5607B
  - MPC5606S
  - o MPC5604E
  - MPC5644A
  - MPC5643L
  - MPC5676R
  - MPC5632M, MPC5633M, MPC5634M
  - MPC5642A
  - o MPC5674F
  - MPC5673K, MPC5674K, MPC5675K

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<sup>&</sup>lt;sup>1</sup> Please note that S32K SDK has Early Access Release status, which means that there could be some limitations and/or issues. Also note, the S32K SDK is available for Windows host only.

<sup>&</sup>lt;sup>2</sup> The plugins to support Diab, iSystem, Lauterbach are not included and have to be installed from the corresponding update site or installation. The current version of the GreenHills plugin is not compatible with Eclipse Neon version, so it should not be used with this release.

#### 2. What's New

S32 Design Studio for Power Architecture 2017.R1 adds support for several new features and resolves a few bugs:

## 2.1. New/Updated device support

• MPC5744B, MPC5744C

#### 2.2. New Features

- Moved to Eclipse Neon 4.6 Framework
- Compiler update see details in compiler release notes in Cross\_Tools\powerpc-eabivle-4\_9
- Updated P&E debug plugins to the latest and greatest versions
- MPC5748G/MPC5746C SDK EAR v.0.8.1 integrated
- AMMCLIB v.1.1.9 integrated

## 2.3. Bug Fixes

- C preprocessor tool added for C++ projects configuration
- The makefile generation is updated to fix and issue with building a project on the Korean version of Windows Code page switch command cannot be executed.
- The Rename Project functionality is improved to cover referenced projects and launch configurations

## 3. System Requirements for Windows Host

## 3.1. Recommended Configuration

- PC with 2.6 GHz Intel® Pentium® compatible processor or better
- 4 GB of RAM
- 4 GB of disk space (when installing full product or updates)
- 3 GB on Windows system disk
- USB port for communications with target hardware
- Ethernet port for communications with target hardware (optional)

## 3.2. Operational Minimum Configuration

PC with 1.8 GHz Intel® Pentium® compatible processor

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#### **System Requirements for Linux Host**

- 2 GB of RAM
- 3.6 GB of disk space (when installing full product or updates)
- 3 GB on Windows system disk
- USB port for communications with target hardware

## 3.3. Host Operating System Support

- Microsoft Windows 7 32-bit and 64-bit
- Microsoft Windows 8/8.1 32-bit and 64-bit
- Microsoft Windows 10 32-bit and 64-bit

S32 Design Studio for Power Architecture 2017.R1 supports all flavours and editions of the above operating systems as limited to the requirements of the Java Runtime Environment.

# 4. System Requirements for Linux Host

## 4.1. Recommended Configuration

- PC with 2.6 GHz Intel® Pentium® compatible processor or better
- 4 GB of RAM
- 4 GB of disk space (when installing full product or updates)
- 3 GB in /tmp directory
- Java 1.8
- USB port for communications with target hardware
- Ethernet port for communications with target hardware (optional)

## 4.2. Operational Minimum Configuration

- PC with 1.8 GHz Intel® Pentium® compatible processor
- 2 GB of RAM
- 3.6 GB of disk space (when installing full product or updates)
- 3 GB in /tmp directory
- Java 1.8

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• USB port for communications with target hardware

## 4.3. Host Operating System Support

- Ubuntu 14.04 64-bit
- Debian 8 64-bit
- CentOS 7 64-bit

# 5. Product WEB page

S32 Design Studio for Power Architecture 2017.R1 product page is <a href="http://www.nxp.com/S32DS">http://www.nxp.com/S32DS</a>. It contains general information about this product, updates, and download links.

## 6. Installation and Licensing

To install S32 Design Studio for Power Architecture 2017.R1, choose the download option that meets your needs.

The installer package contains the complete S32 Design Studio for Power Architecture 2017.R1 suite and an installer. All data needed by the installer is included in the package and no other download will be performed<sup>3</sup>. Run the installation package and a wizard will guide you through the installation process.

During installation the license activation will be requested. The following types of activations are supported:

- Online activation, requires internet access and the request for license will be sent automatically
- Offline activation, no internet access is required, the offline activation request is generated and should be passed, by the user, to the licensing site to get the activation response, which the user should then load back into the installer.

S32 Design Studio supports installation of updates. The update may consist of a new devices support, defect fixes or it can add a new functionality across the device families.

New support can be added directly from the Internet or from a downloaded archive. If your computer is connected to the Internet, select Install New Software in the Help Menu and all available updates will be displayed. If your computer does not have Internet access, you can download the archive that contains the service pack, update or patch you need from product page and follow the Service Pack Updater procedure posted on the site.

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<sup>&</sup>lt;sup>3</sup> The plugins to support 3rd party compilers or debuggers are not included and have to be installed from corresponding update site or installation.

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# 7. Technical Support

S32 Design Studio issues are tracked through the S32DS Public NXP Community space:

https://community.nxp.com/community/s32/s32ds .

For confidential cases and cases which cannot be publicly shared on NXP Community please follow the steps described here:

https://community.nxp.com/docs/DOC-329745

# **Appendix A. Known issues and Workarounds**

- Conditional watchpoints and breakpoints: Conditional breakpoints and watchpoints, including those using ignore counts, do not work consistently.
  - **Workaround**: Do not use conditions for breakpoints and watchpoints, instead check for the condition in the code and set a normal breakpoint.
- **ATTENTION:** If the linker file being used in your project is missing the KEEP (\*(.init) and KEEP (\*(.fini)) statements (see example below), the initialization code will not have closing statements and will not return to main.

**Workaround:** Update the linker file to include the statements. Any newly created projects will include the necessary and required statements in linker file. More details could be found by link - https://community.nxp.com/docs/DOC-335361

**Recommendation**: Create a new project for the corresponding device, compare and add missing statements.

```
SECTIONS {
    ...
    .text :
    {
        ...
        KEEP (*(.init))
        KEEP (*(.fini))
```

#### **NOTE**

The projects created by older version of S32DS will be detected during opening and automated fix will be proposed.

- Uninstallation of P&E drivers: The P&E Device Drivers item will remain in the Control Panel/ Programs and Features after uninstallation of S32 Design Studio, if user will try to use this item to uninstall error message appeared, the user should ignore it. But the drivers will remain in the system.
  - **Workaround**: P&E drivers should be uninstalled before the product uninstallation. But one should be careful if several products are using P&E drivers.
- **Debugger might fail for MPC5777M** when stopped on main() and memory window opened at address 0xFFE68000 and step performed (before initialization done).
  - **Workaround**: Open memory window at that address after xcptn\_xmpl() is executed.
- Disassembly view content might be destroyed occasionally.
   Workaround: Close disassembly view and open it again using menu Window → Show View → Disassembly.
- **USB driver conflict** between P&E and Xilinx software: P&E Drivers for Windows utilize the 3rd party service Jungo WinDriver to enable USB support under windows XP/7/8.x/10. Xilinx also uses WinDriver for their driver packages, but older versions. Starting with the P&E Driver package 11.7, a conflict between P&E Drivers and software IDES that rely on older Jungo driver

packages might occur. This is because both the old and new driver packages utilize the same .sys file (windrvr6.sys). When the new P&E Drivers are installed, Xilinx tools stop working after 30 days because the new sys file requires a new license that the older Xilinx software does not have. **Workaround**: Please follow the steps in P&E's FAQ 255 for installing an older version of P&E Drivers (11.1) to resolve Xilinx conflict under Windows XP/7/8.x.

http://www.pemicro.com/website\_management/faq\_view.cfm?id=225

If drivers issue persists, please submit a support request to P&E Microcomputer Systems: http://www.pemicro.com/support/index.cfm

- Missing license could be reported on IDE start.
   Workaround: same activation ID should be entered.
- Problems could be experienced while debugging of elf file generated by GHS compiler like missing call stack information, incorrect info on step into function, etc.
   Workaround: On occasion GHS generates GDB incompatible debug information preventing the debugger from displaying the call stack. In some cases, without such information gdb can still debug your program. The program build needs to be augmented with a post-build step, select the project in the project explorer view and File->Properties to display the project properties, under C/C++ Build -> Settings select the build steps tab and enter the command gstrip r=.debug\_frame executable. Switch to Instruction Stepping Mode to be able to step through function. If this workaround does not help please report issue to GreenHills support.
- **Hyperlinks** might not work correctly under Windows 10 when Microsoft Edge is default browser

Workaround: Set another browser as default.

LSM or DPM device mode selection for MPC5643L: MPC5643L device provides user with capability to configure the processor to boot up in Lock-Step Mode (LSM) or Dual-Processor Mode(DPM) out of reset. One is required to re-flash a dedicated control byte in shadow block of FLASH memory to switch back and forth between LSM and DPM modes
 Workaround: This can be safely achieved by using a dedicated FLASH programming algorithm within evaluation version of PROGPPCNEXUS FLASH programming software from P&E Microcomputer Systems. Please refer to the following FAQ for a download link and step by step LSM/DPM mode switching directions -

http://www.pemicro.com/website management/faq view.cfm?id=227

#### NOTE

There are some issues which are introduced by CDT therefore reproduced in S32 Design Studio. Those issues might be fixed when the fix is available with newer CDT version and when S32 Design Studio migrates to it.

## **Appendix B. Performance Considerations**

The following suggestions will help keep the S32 Design Studio tools running at a respectable performance level.

- 1. To maximize performance, the S32 Design Studio tools should be installed on a computer with the recommended system configuration. While the tools will operate on a computer with the minimum configuration, the limited hardware will restrict its ability to function at desired performance levels.
- 2. Close unused projects. Eclipse caches files for all open projects in the workspace. If you need multiple projects open, try to limit the number of projects to no more than 10.
- 3. The Eclipse IDE provides several options that provide user assistance tools. These options, however, use memory and cpu bandwidth. If performance is slow and you do not need these options, turn them off.
- Scalability options configure how eclipse deals with large source files.
  - Scalability options:
    - Editor live parsing: impacts parsing while typing, Outline View, semantic highlighting, folding, etc.
    - Semantic highlighting: C/C++ identifiers are colored
    - Syntax coloring: coloring of keywords, comments and literals
    - Parsing—based content assist proposals: content assist proposals which require parsing the file
    - Content assist auto activation: content assist activated automatically on trigger sequences, like '.', '::' or '->'.
  - To disable
    - Click menu 'Window' -> 'Preference'
    - Expand 'C/C++' -> 'Editor' -> 'Scalability'
    - Uncheck 'Enable all scalability mode options'
- Content Assist Auto Activation can reduce the number of keystrokes a developer must type to create code. The Content Assist plug-in consists of components that predict what a developer will type, based on the current context, scope and prefix.
  - To disable:
    - Click menu 'Window' -> 'Preference'
    - Expand 'C/C++' -> 'Editor' -> 'Content Assist'
    - Uncheck all the options for 'Auto-Activation'

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